imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





THIS SPECIFICATION APPLIES TO THE ELECTROMAGNETIC BUZZER

SPECIFICATION

Test condition: TEMP=+25±2 ℃ Related humidity=65±5% Air pressure:860-1060mbar

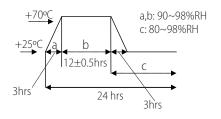
item	unit	specification	condition
rated voltage	Vo-p	1.5	Vo-p
operating volt	Vo-p	1-3	OV
mean current	mA	Max.80	At rated voltage 2730Hz, square wave, 1/2 duty
coil resistance	Ω	6 ± 1%	
sound output	dBA	85	At 10cm(A-weight free air), at rated voltage
			2730Hz, square wave, 1/2duty
rated frequency	Hz	2730	
operating temp	°C	-20 ~ +60	
storage temp	°C	-30 ~ +70	
dimension	mm	φ9.0×H4.5	See attached drawing
weight	gram	0.6	
material		PPO (Black)	
terminal		Pin type (Plating Au)	See attached drawing
environmental		RoHS	
protection regulation			

ENVIRONMENT TEST

item	test condition	evaluation standard
 high temp. test	After being placed in a chamber at +70°C for 96 hours.	After the test the part will meet specifications without any degradation in appearance and
 low temp. test	After being placed in a chamber at -30°C for 96 hours.	performance except SPL after 4 hours at +25°C. The SPL will be in ±10dBA compared with initial
thermal shock	The part will be subjected to 10 cycles. One cycle shall consist of: +70°C -30°C -30°C -30 min 60 min	one.

temp./humidity cycle

The part will be subjected to 10 cycles. One cycle shall be 24 hours and consist of:





RELIABILITY TEST

item	test conditions	evaluation standard
operating life test	ORDINARY TEMPERATURE	After the test the part will meet specifications
	The part will be subjected to 96 hours of	without any degradation in appearance and
	continuous operation at +25 \pm 10°C.	performance except SPL, after 4 hours at +25°C.
	HIGH TEMPERATURE	The SPL would be in ± 10 dBA compared with
	The part will be subjected to 72 hours of	initial one.
	continuous operation at +60°C with 1.5V,	
	2730Hz applied.	
	LOW TEMPERATURE	-
	The part will be subjected to 72 hours of	
	continuous operation at -20°C with 1.5V, 2730Hz	
	applied.	

TEST CONDITION

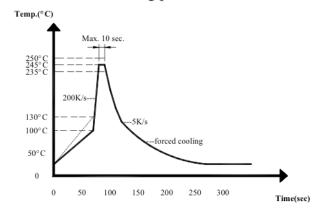
Standard Test Condition : a)Temperature: +5~+35°C b)Humidity:45~85% c)Pressure: 860~1060mbar

MECHANICAL CHARACTERISTICS

item	test conditions	evaluation standard
solderability	Lead terminal are immersed in rosin for 5	90% min. lead terminals will be wet with solder
	seconds and then immersed in solder bath of	No interference in operation.
	+260±5°C for 3±0.5 seconds.	
soldering heat resistance	Lead terminal are immersed in soldering bath of	-
	+260±5°C for 2±0.5 seconds.	
terminal mechanical	Apply the terminal with 1KG strength for 10 \pm 1	No damage and cutting off.
strength	seconds.	
vibration	The part will be subjected to a vibration cycle of	After the test the part will meet specifications
	10Hz to 55Hz to 10Hz in a period of 1 minute.	without any damage in appearance and
	Total peak amplitude will be 1.52mm(9.3G). The	performance except SPL.
	vibration test will consist of 2 hours per axis in	The SPL would be in ± 10 dBA compared with
	each three axes(X,Y,Z). Total 6 hours.	initial one.
drop test	The part only will be dropped from a height of	-
	75cm onto a 40mm thick wooden board 3 times	
	in 3 axes(X,Y,Z). Total of 9 times.	

RECOMMENDED WAVE SOLDERING TEMPERATURE CURVE

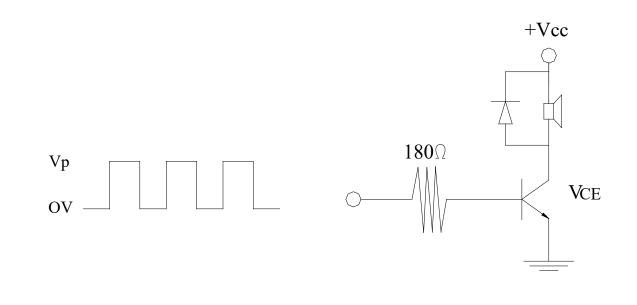
* Wave Soldering profile of lead-free



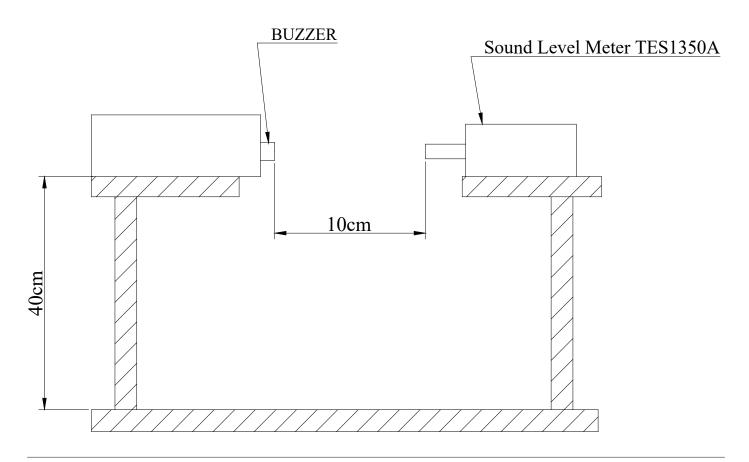
Recommendable wave soldering condition is as follows: Note 1: It is requested that wave soldering should be executed after heat of product goes down to normal temperature. Note 2: Peak wave temperature of 235°C -235°C maximum of 10 seconds.



MEASUREMENT TEST CIRCUIT



INSPECTION FIXTURE

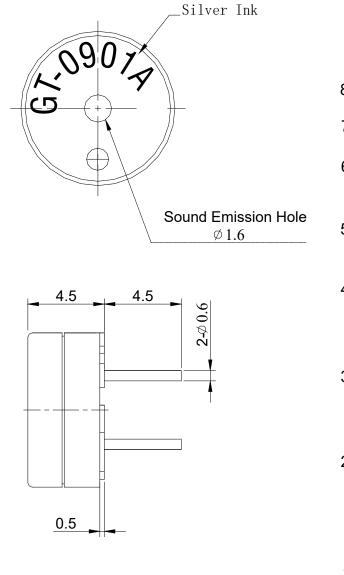


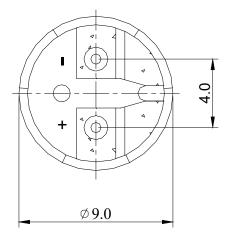


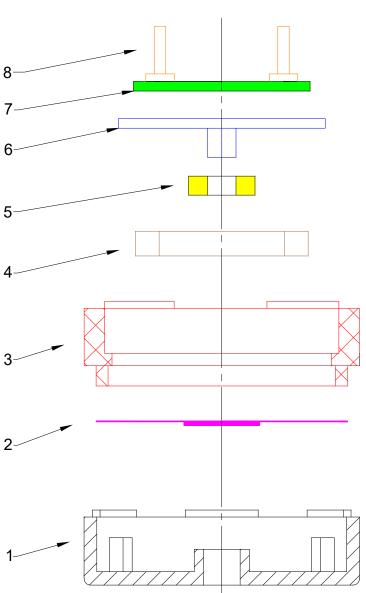
MODEL: GT-0901A PRODUCT: Electromagnetic Buzzer EDITION: A/2016

DIMENSIONS

. Tolerance:±0.5 (unit: mm)





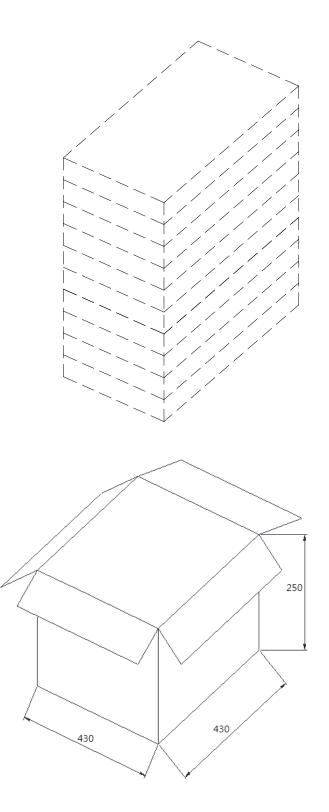


no	item	material	quantity
1	CASE	PPO	1
2	Diaphragm	Ferrum	1
3	CASE	PPO	1
4	Magnet ring	NdFeB	1
5	Coil	Copper	1
6	Core	Ferrum	1
7	PCB	Epoxy glass fiber cloth + copper	1
8	PIN	Copper	2



MODEL: GT-0901A PRODUCT: Electromagnetic Buzzer EDITION: A/2016

PACKING



packing box	LxWxH (mm)	pieces
Tray	190x190x25	100
Inner cartons	210x210x220	1600
Outer cartons	430x430x250	6000